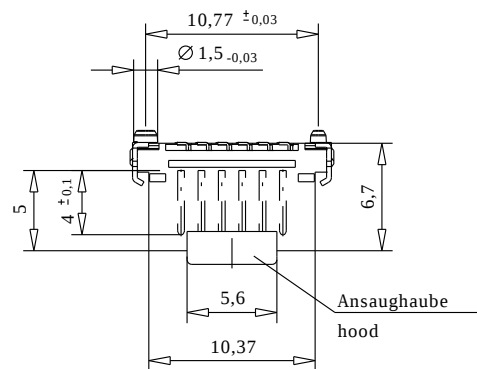
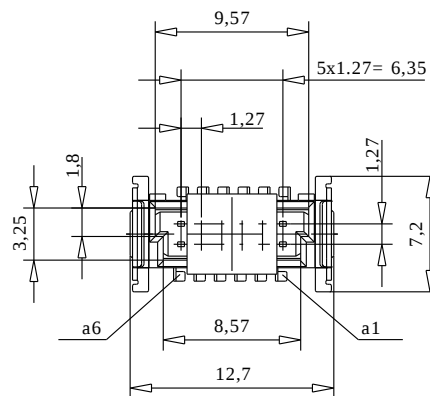
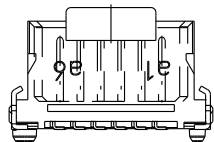
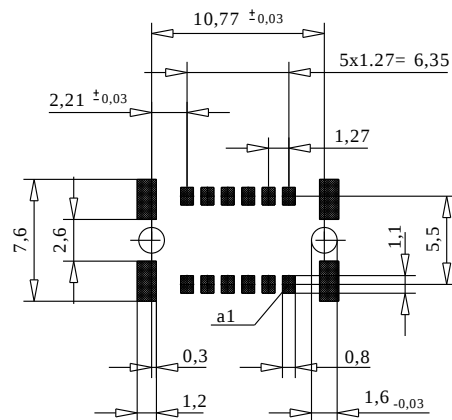


Leiterplatten-Layout Vorschlag für SMT

PCB-Layout Proposal for SMT



Anforderungsstufe 1
Performance Level 1

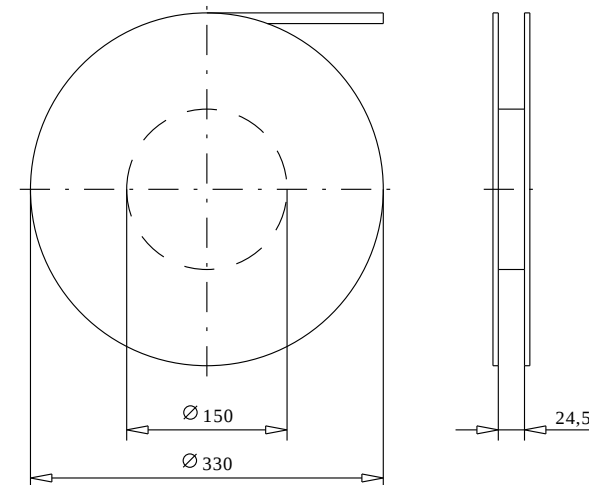
Kontaktbereich vergoldet
Mating Area gold plating

Anschlussbereich verzinkt 4-6 µm
Terminal Area 4-6 µm tin plating

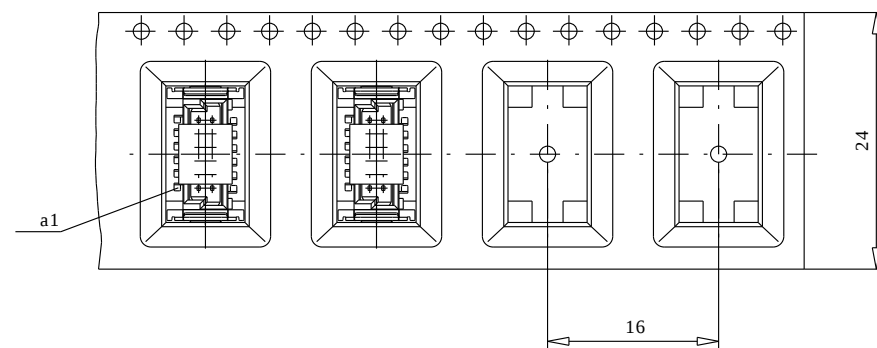
Koplanarität der Anschlüsse ≤ 0.1mm
Coplanarity Area of Termination ≤ 0.1 mm

Verpackt in Gurtverpackung
Verpackungseinheit: 280 Stück

- Tape on Reel Packaging
- Packaging unit: 280 pcs



Abspulrichtung - Reel off Direction



BA7-13 - 8 mm Bauhöhe

type7-13 - Low Profile

Information:			Tolerances		 All Dimensions in mm	Scale 3:1	Angaben zu entsprechender Ident-Nr. siehe Fertigungsunterlagen For further information about I.D. number see manufacturing document.	
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						Messerl. SMC-Q 12-SMD-BA7-13 Male SMC-Q 12-SMD-type7-13		
			 www.ERNI.com			154818		
a		11.08.2006	V:00058687.SZA			SMC		
Index		Date						

Consider protection memo from DIN 34